

# **Description**

The FMX-12S is a fast recovery diode of 200 V / 5 A. The maximum  $t_{rr}$  of 30 ns is realized by optimizing a life-time control.

#### **Features**

•	$V_{RM}$	V
•	$I_{F(AV)} 5$	A
	V <sub>F</sub> 0.98	
•	$t_{rr1}$ 30	ns

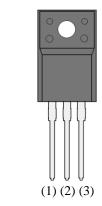
- Bare Lead Frame: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0

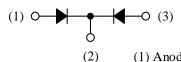
# **Applications**

- Secondary-side Rectifier Diode (Flyback Converter, LLC Converter, etc.)
- Freewheel Diode (Offline Buck Converter, Offline Buck-boost Converter, etc.)

# **Package**

TO220F-3L





- (1) Anode
  - (2) Cathode
  - (3) Anode

Not to scale

# **FMX-12S**

# **Absolute Maximum Ratings**

Unless otherwise specified,  $T_A = 25$  °C.

Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage <sup>(1)</sup>	$V_{RSM}$		200	V
Repetitive Peak Reverse Voltage <sup>(1)</sup>	$V_{RM}$		200	V
Average Forward Current	$I_{F(AV)}$	See Figure 1 and Figure 2	5	A
Surge Forward Current <sup>(1)</sup>	$I_{FSM}$	Half cycle sine wave, positive side, 10 ms, 1 shot	35	A
I <sup>2</sup> t Limiting Value <sup>(1)</sup>	$I^2t$	$1 \text{ ms} \le t \le 10 \text{ ms}$	6.1	$A^2s$
Junction Temperature	$T_{J}$		-40 to 150	°C
Storage Temperature	$T_{STG}$		-40 to 150	°C

#### **Electrical Characteristics**

Unless otherwise specified,  $T_A = 25$  °C.

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage Dron(1)	$V_{\mathrm{F}}$	$T_J = 25$ °C, $I_F = 2.5$ A			0.98	V
Forward Voltage Drop <sup>(1)</sup>		$T_J = 100  ^{\circ}\text{C},  I_F = 2.5  \text{A}$	_	0.74	_	V
Reverse Leakage Current <sup>(1)</sup>	$I_R$	$V_R = V_{RM}$	_	_	50	μΑ
Reverse Leakage Current under High Temperature <sup>(1)</sup>	$H \cdot I_R$	$V_R = V_{RM}, T_J = 150  ^{\circ}C$	_		10	mA
	t <sub>rr1</sub>	$I_F = I_{RP} = 100 \text{ mA},$ 90% recovery point, $T_J = 25 ^{\circ}\text{C}$	_	_	30	ns
Reverse Recovery Time <sup>(1)</sup>	t <sub>rr2</sub>	$I_F = 100 \text{ mA},$ $I_{RP} = 200 \text{ mA},$ $75\% \text{ recovery point},$ $T_J = 25 \text{ °C}$	_	_	25	ns
Thermal Resistance <sup>(2)</sup>	$R_{\text{th(J-C)}}$				4.0	°C/W

# **Mechanical Characteristics**

Parameter	Conditions	Min.	Тур.	Max.	Unit
Heatsink Mounting Screw Torque		0.490	_	0.686	N·m

 $<sup>^{\</sup>left(1\right)}$  Specifies a value per chip; the FMX-12S consists of two chips.

 $<sup>^{(2)}</sup>$   $R_{th (J-C)}$  is thermal resistance between junction and the case. The case temperature is measured at the back side near the screw hole.

# **Rating and Characteristic Curves**

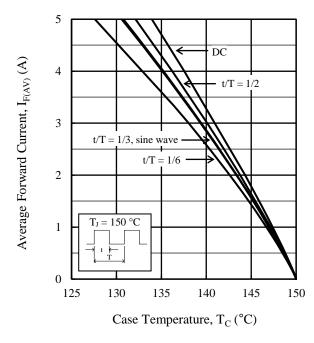


Figure 1. Typical Characteristics:  $I_{F(AV)}$  vs.  $T_{C}$  ( $V_{R}=0\ V$ )

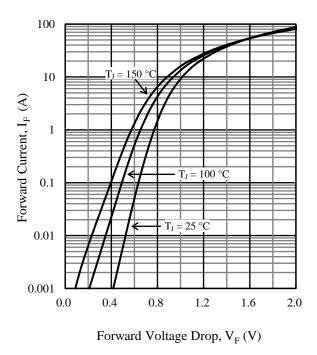


Figure 3. Typical Characteristics: I<sub>F</sub> vs. V<sub>F</sub>

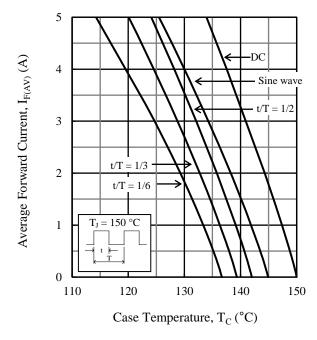


Figure 2. Typical Characteristics:  $I_{F(AV)}$  vs.  $T_{C}$  ( $V_{R} = 200 \text{ V}$ )

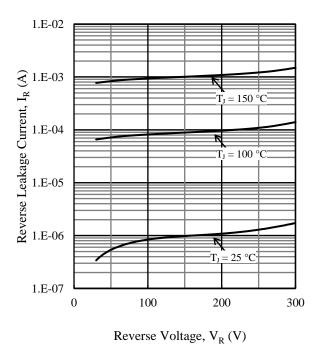
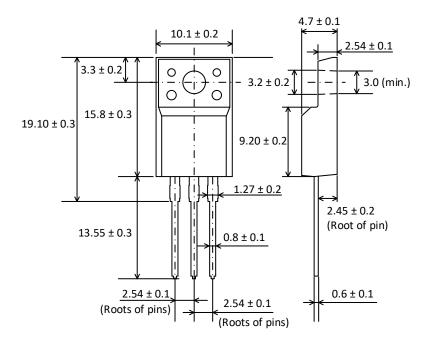


Figure 4. Typical Characteristics: I<sub>R</sub> vs. V<sub>R</sub>

# **Physical Dimensions**

• TO220F-3L



#### **NOTES:**

- Dimensions in millimeters
- All the dimensions exclude mold flashes.
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time within the following limits:

Flow:  $260 \pm 5$  °C /  $10 \pm 1$  s, 2 times

Soldering Iron:  $380 \pm 10$  °C /  $3.5 \pm 0.5$  s, 1 time

Soldering should be at a distance of at least 1.5 mm from the body of the product.

#### **Marking Diagram**

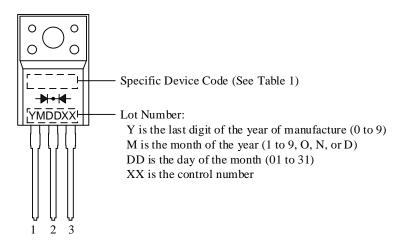


Table 1. Specific Device Code

Specific Device Code	Part Number
FMX12S	FMX-12S

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DSGN-CEZ-16003